

Supporting information

Se vacancies-driven nickel cobalt selenides electrode for boosting supercapacitive performance

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Supplementary Figure

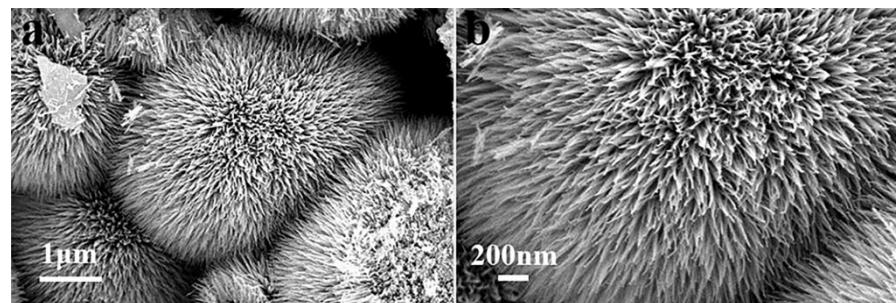


Fig. S1. SEM images of the (a-b) NiCo precursor.

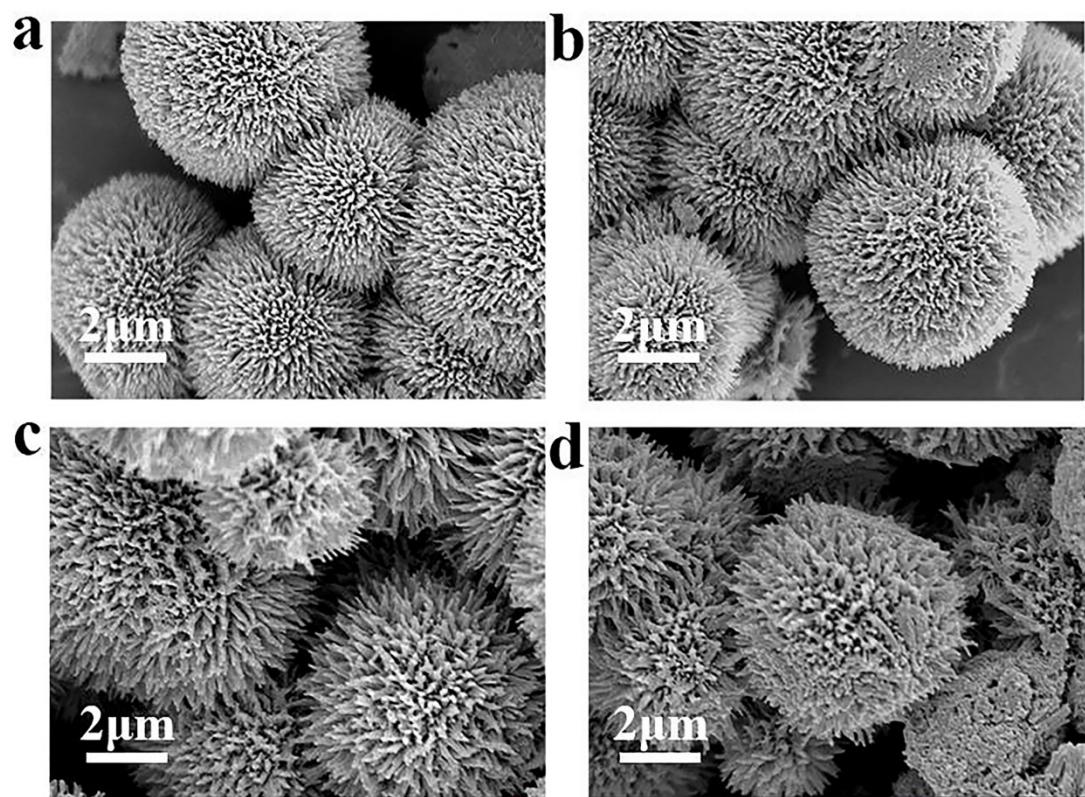


Fig. S2. SEM images of (a) V_{0.5}-NiCo₂Se_x, (b) V₁-NiCo₂Se_x, (c) V_{1.5}-NiCo₂Se_x, (d) V_{2.5}-NiCo₂Se_x.

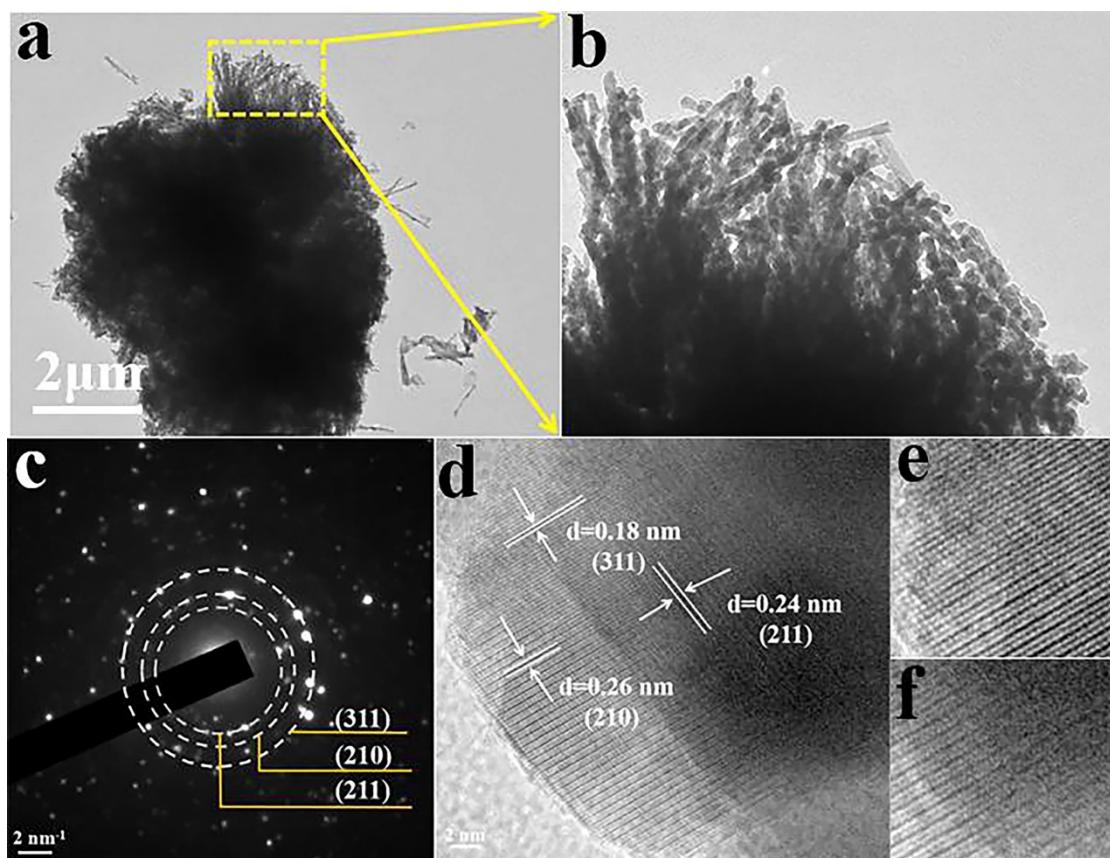


Fig. S3. (a-b) TEM images, (c) SAED images, (d-f) HRTEM images of the Pure-NiCo₂Se₄.

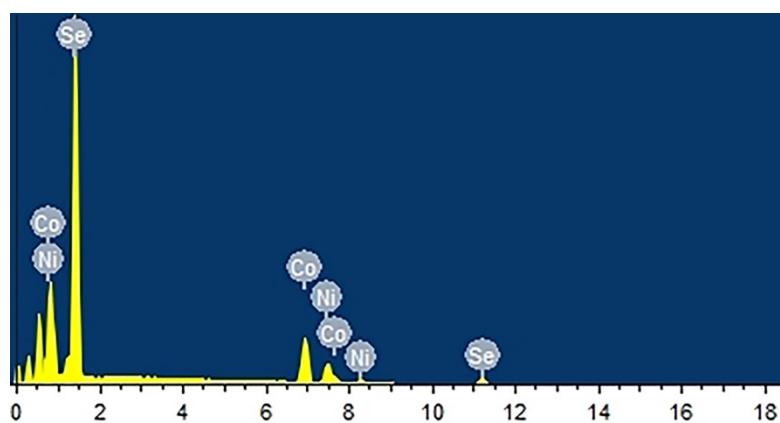


Fig. S4. Elemental analysis results from energy dispersive spectrometer in scanning electron microscopy (SEM-EDS) spectrum of V₂-NiCo₂Se_x.

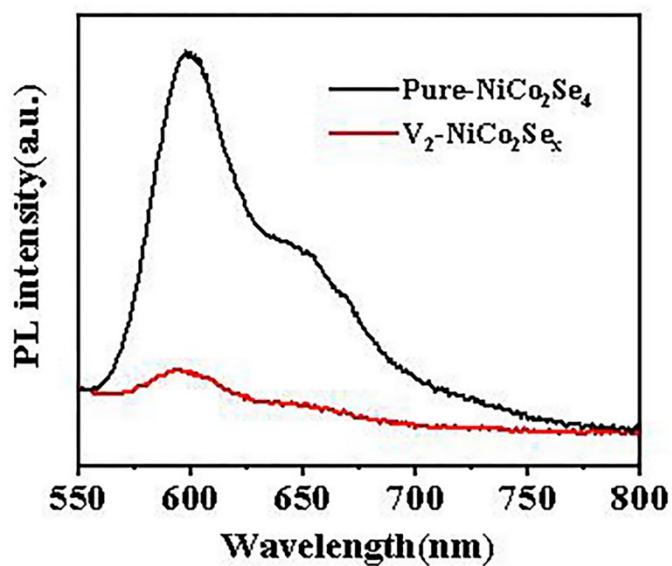


Fig. S5. PL spectras of Pure-NiCo₂Se₄ and V₂-NiCo₂Se_x.

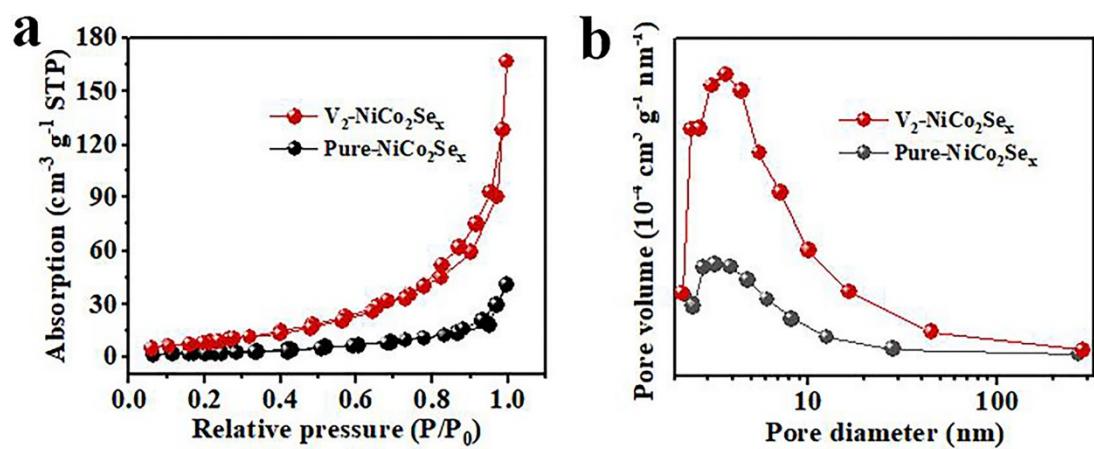


Fig. S6. (a) N₂ adsorption/desorption isotherm, (b) pore size distribution of Pure-NiCo₂Se₄

and V₂-NiCo₂Se_x.

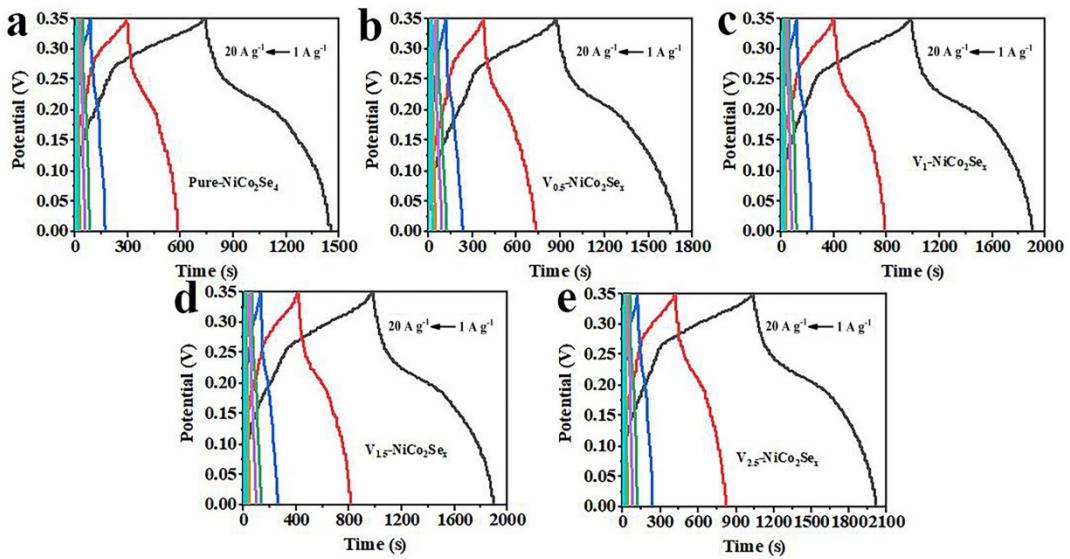


Fig. S7. GCD curves of (a) Pure-NiCo₂Se₄, (b) V_{0.5}-NiCo₂Se_x, (c) V₁-NiCo₂Se_x, (d) V_{1.5}-NiCo₂Se_x and (e) V_{2.5}-NiCo₂Se_x under different current densities

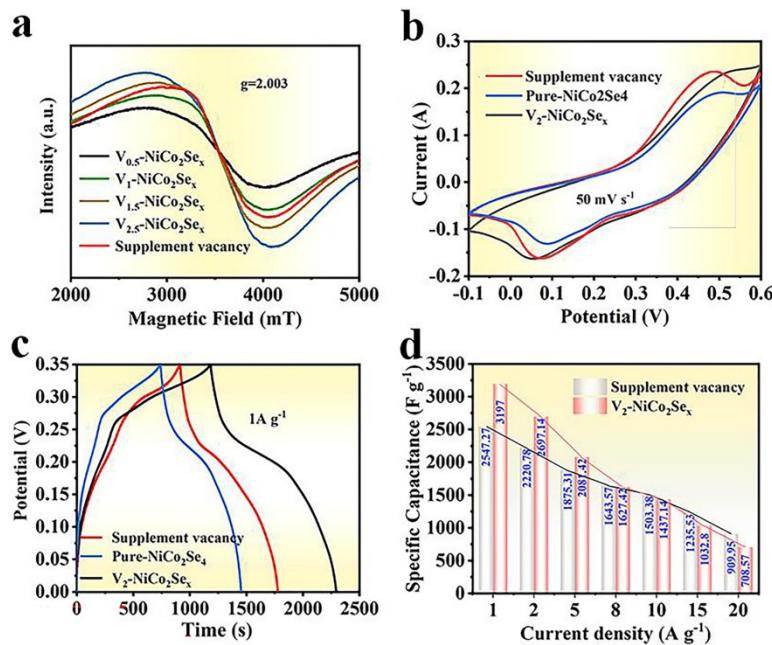


Fig. S8. (a) EPR spectra of vacancy supplement material and V_{0.5}-NiCo₂Se_x, V₁-NiCo₂Se_x, V_{1.5}-NiCo₂Se_x and V_{2.5}-NiCo₂Se_x, (b) CV curves of vacancy supplement material and Pure-NiCo₂Se₄ and V₂-NiCo₂Se_x, (c) GCD curve comparison of vacancy supplement material and Pure-NiCo₂Se₄ and V₂-NiCo₂Se_x, (d) specific capacity of vacancy supplement material and V₂-NiCo₂Se_x as a function of current density.

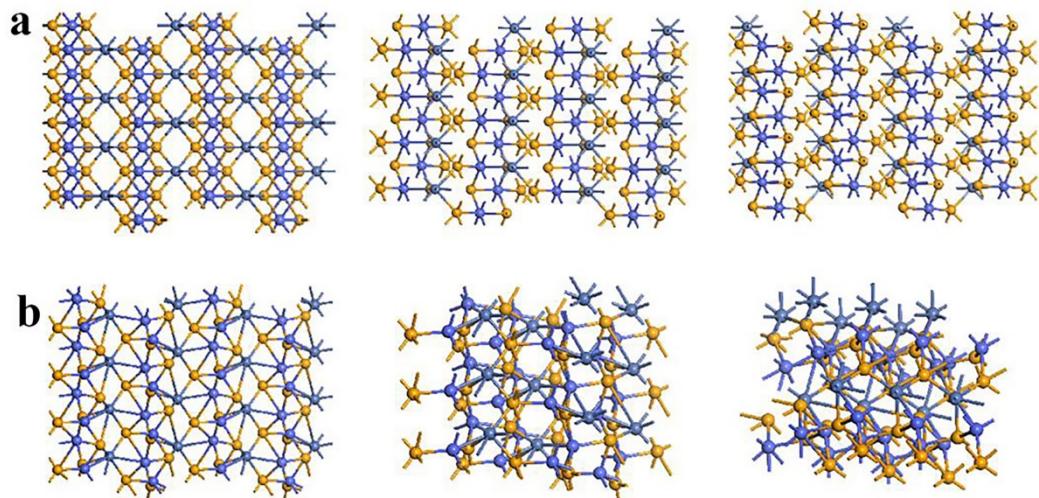


Fig. S9. Crystal structure optimization of (a) Pure- NiCo_2Se_4 and (b) $\text{V}_2\text{-NiCo}_2\text{Se}_x$.

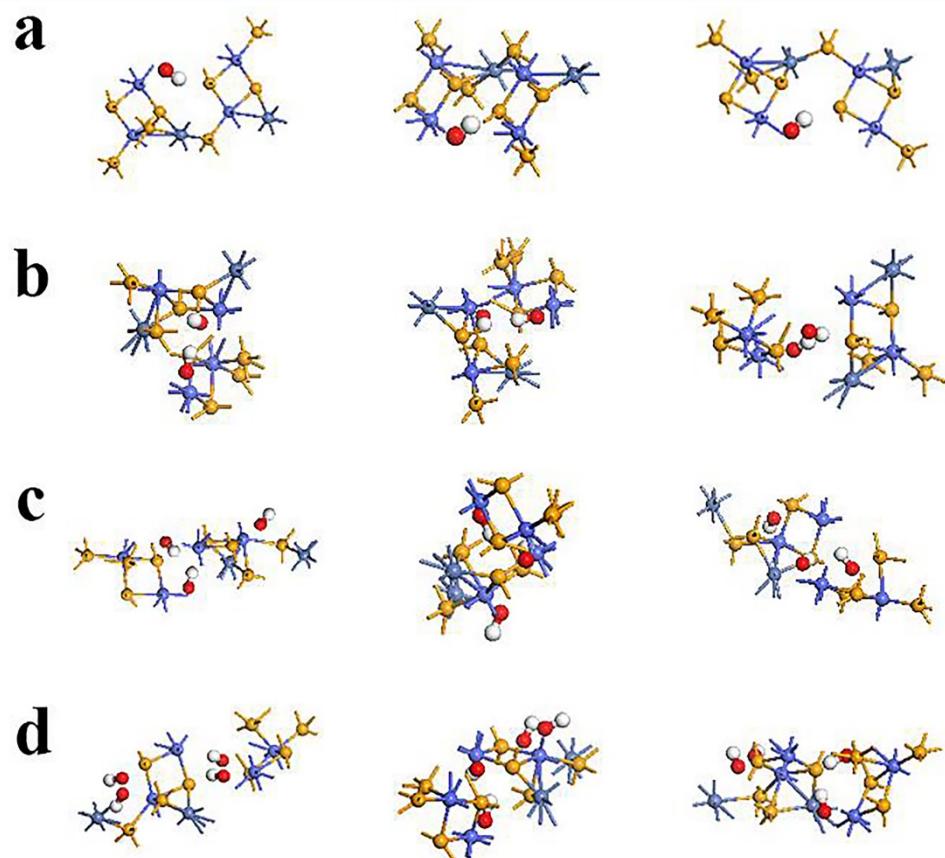


Fig. S10. Pure- NiCo_2Se_4 adsorption (a) one OH^- , (b) two OH^- , (b) three OH^- , (b) four OH^- structure diagram.

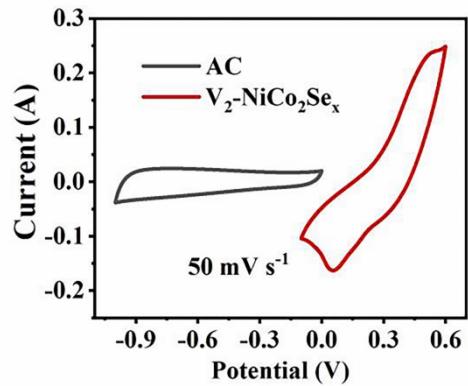


Fig. S11. Comparison of CV curves of AC electrode and $V_2\text{-NiCo}_2\text{Se}_x$ electrode at 50 mV s^{-1}

scanning rate.

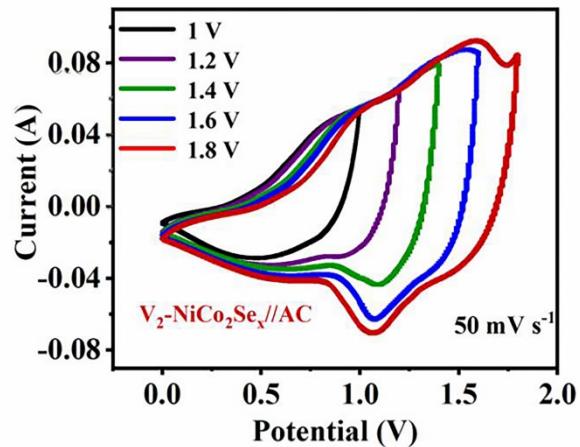


Fig. S12. CV curves for different voltage windows at a scan rate of 50 mV s^{-1} .

Supplementary Table

Table S1. EDS element contents of Pure-NiCo₂Se₄ and V_a-NiCo₂Se_x.

Electrode	Ni (Atomic)	Co (Atomic)	Se (Atomic)
material			
Pure-NiCo ₂ Se ₄	14.05%	26.02%	59.93%
V _{0.5} -NiCo ₂ Se _x	15.31%	27.17%	57.52%
V ₁ -NiCo ₂ Se _x	16.11%	30.36%	53.53%
V _{1.5} -NiCo ₂ Se _x	16.89%	31.12%	51.99%
V ₂ -NiCo ₂ Se _x	16.95%	32.68%	50.37%
V _{2.5} -NiCo ₂ Se _x	17.11%	33.19%	49.70%

Table S2. Percentage contents of Ni²⁺/Ni³⁺, Co²⁺/Co³⁺ and Se 3d_{3/2}/Se 3d_{5/2} by Pure-NiCo₂Se_x and V_a-NiCo₂Se_x.

Material	Co ²⁺ /Co ³⁺	Ni ²⁺ /Ni ³⁺	Se 3d _{3/2} /Se 3d _{5/2}
Pure-NiCo ₂ Se _x	0.4605	0.6677	1.2970
V _{0.5} -NiCo ₂ Se _x	2.2784	0.2661	1.4429
V ₁ -NiCo ₂ Se _x	2.4176	0.1926	2.1350
V _{1.5} -NiCo ₂ Se _x	4.2671	0.1407	2.4004
V ₂ -NiCo ₂ Se _x	6.3225	0.1276	3.2127
V _{2.5} -NiCo ₂ Se _x	9.6260	0.04	5.0889

Table S3. Power density and energy density comparison of V₂-NiCo₂Se_x with recently reported Ni/Co-based electrode materials.

Supercapacitor device	Energy density (Wh kg ⁻¹)	Power density (W kg ⁻¹)	Reference
Ni ₂ Co ₄ Se//HPC	34.8	399.9	1
CoSe ₂ /NiSe ₂ //AC	27.8	750.0	2
(Ni _{0.33} Co _{0.67})Se ₂ CHSs//AC	29.1	800	3
NiCoSe//AC	16	750	4
Ni _{0.67} Co _{0.33} Se//RGO	36.7	750	5
NiCo ₂ Se ₄ /MXene//AC	22.4	800	6
Ni-Co-Se//AC	38.5	802.1	7
(Ni _{0.5} Co _{0.5}) _{0.85} Se//carbon	70.58	320.02	8
NiCoSe ₂ //AC	44.4	776.7	9
V ₂ -NiCo ₂ Se _x //AC	76.45	800.06	This work
	39.48	16030.14	

References

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